

PROTECTION PRODUCTS - MicroClamp[®]
Description

The μ Clamp[®] series of Transient Voltage Suppressors (TVS) are designed to replace multilayer varistors (MLVs) in portable applications such as cell phones, notebook computers, and PDAs. They offer superior electrical characteristics such as lower clamping voltage and no device degradation when compared to MLVs. They are designed to protect sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD), lightning, electrical fast transients (EFT), and cable discharge events (CDE).

The μ Clamp[®]2501T is constructed using Semtech's proprietary EPD TVS process technology. The EPD process provides low operating voltages with significant reductions in leakage currents and capacitance over silicon-avalanche diode processes. They feature a true sub 5 volt operating voltage for superior protection when compared to traditional pn junction devices.

The μ Clamp2501T is in a 2-pin SLP1006P2T package. It measures 1.0 x 0.6 x 0.4mm. The leads are spaced at a pitch of 0.65mm and are finished with lead-free NiPdAu. Each device will protect one line operating at 2.5 volts. It gives the designer the flexibility to protect single lines in applications where arrays are not practical. They may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 (± 15 kV air, ± 8 kV contact discharge). The combination of small size and high ESD surge capability makes them ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Features

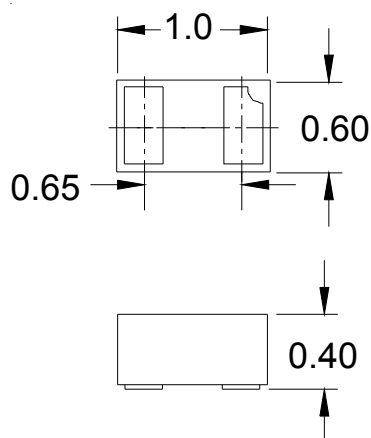
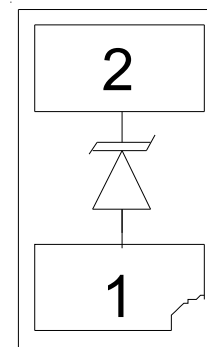
- ◆ Transient protection for data lines to **IEC 61000-4-2 (ESD) ± 15 kV (air), ± 8 kV (contact)**
IEC 61000-4-4 (EFT) 40A (tp = 5/50ns)
Cable Discharge Event (CDE)
- ◆ Ultra-small package (1.0 x 0.6 x 0.4mm)
- ◆ Low leakage current: <10nA typical (VR=2.5V)
- ◆ Low Operating voltage: 2.5V
- ◆ Low capacitance
- ◆ Protects one data line
- ◆ Solid-state silicon-avalanche technology

Mechanical Characteristics

- ◆ SLP1006P2T package
- ◆ Pb-Free, Halogen Free, RoHS/WEEE Compliant
- ◆ Nominal Dimensions: 1.0 x 0.6 x 0.4 mm
- ◆ Lead Finish: NiPdAu
- ◆ Molding compound flammability rating: UL 94V-0
- ◆ Marking : Marking code, cathode band
- ◆ Packaging : Tape and Reel

Applications

- ◆ Cellular Handsets & Accessories
- ◆ Portable Instrumentation
- ◆ Keypads, Side Keys, LCD Displays
- ◆ Notebooks & Desktop Computers
- ◆ mp3 Players

Dimensions

Nominal Dimensions (mm)
Schematic & PIN Configuration

SLP1006P2T (Bottom View)

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Absolute Maximum Rating

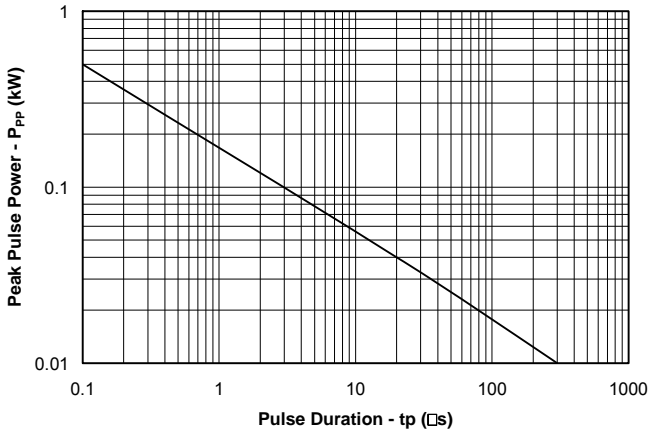
Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20μs)	P_{pk}	40	Watts
Maximum Peak Pulse Current (tp = 8/20μs)	I_{pp}	5	Amps
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V_{ESD}	+/- 20 +/- 15	kV
Operating Temperature	T_J	-40 to +85	°C
Storage Temperature	T_{STG}	-55 to +150	°C

Electrical Characteristics (T=25°C)

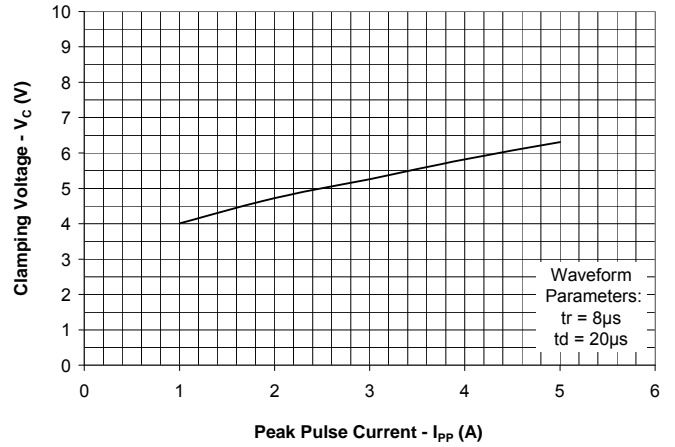
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				2.5	V
Punch-Through Voltage	V_{PT}	$I_{PT} = 2\mu A$	2.7	3.1	3.6	V
Snap-Back Voltage	V_{SB}	$I_{SB} = 50mA$	2.8			V
Reverse Leakage Current	I_R	$V_{RWM} = 2.5V$		0.01	0.05	μA
Clamping Voltage	V_C	$I_{PP} = 1A, t_p = 8/20\mu s$			5	V
Clamping Voltage	V_C	$I_{PP} = 5A, t_p = 8/20\mu s$			7.5	V
Forward Voltage	V_F	$I_{PP} = 1A, t_p = 8/20\mu s$			2.4	V
Junction Capacitance	C_j	Pin 2 to 1 $V_R = 0V, f = 1MHz$		25	30	pF
		Pin 2 to 1 $V_R = 2.5V, f = 1MHz$		14		pF

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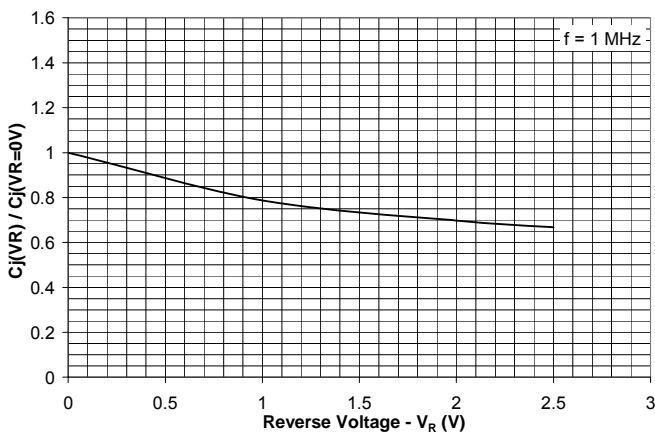
Non-Repetitive Peak Pulse Power vs. Pulse Time



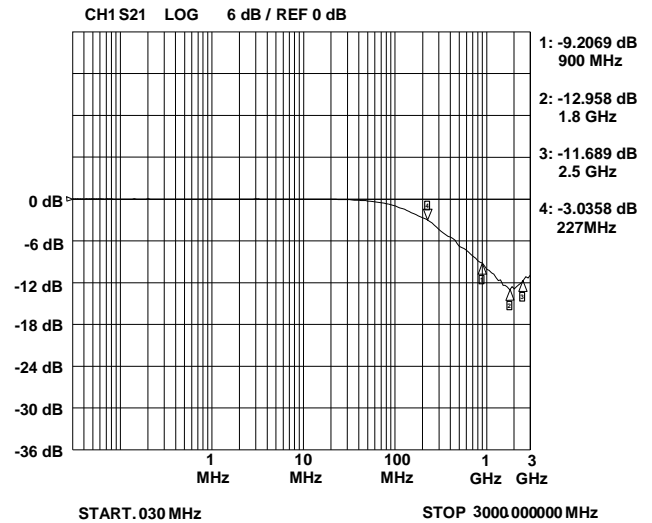
Clamping Voltage vs. Peak Pulse Current



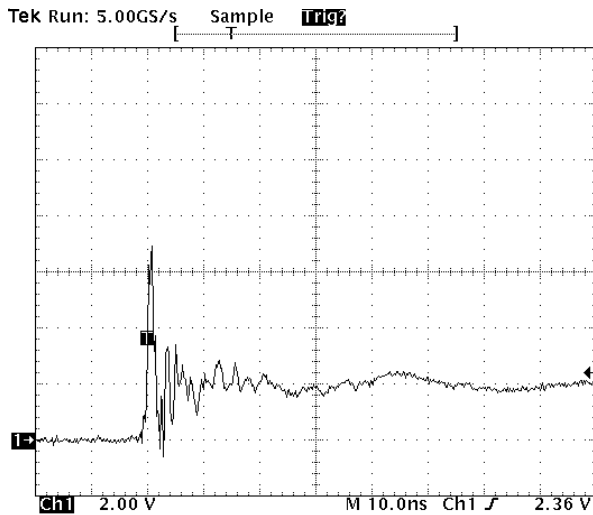
Normalized Junction Capacitance vs. Reverse Voltage



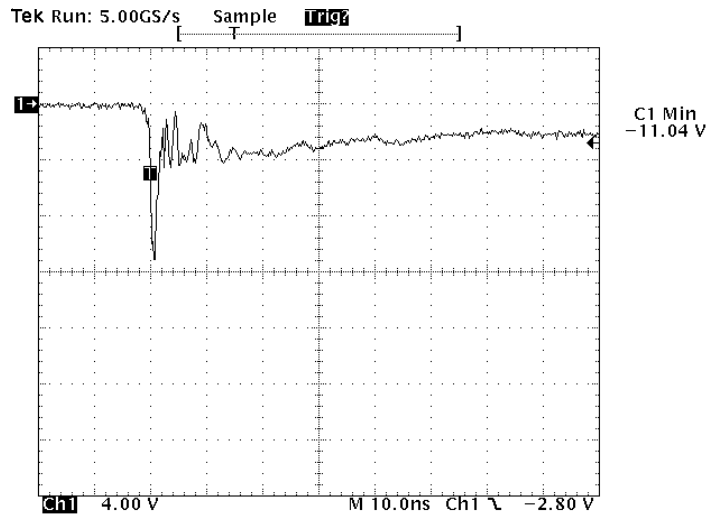
Typical Insertion Loss (S21)



ESD Clamping (Pin 2 to 1) (8kV Contact per IEC 61000-4-2)



ESD Clamping (Pin 1 to 2) (-8kV Contact per IEC 61000-4-2)



Note: Data is taken with a 10x attenuator

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PROTECTION PRODUCTS**Applications Information****Device Connection Options**

The μ Clamp2501T is designed to protect one data line operating up to 2.5 volts. It will present a high impedance to the protected line up to 2.5 volts. It will “turn on” when the line voltage exceeds 2.7 volts. The device is unidirectional and may be used on lines where the signal polarity is above ground. These devices are not recommended for use on DC power supply lines due to their snap-back voltage characteristic.

EPD TVS Characteristics

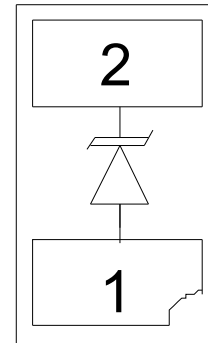
These devices are constructed using Semtech’s proprietary EPD technology. The structure of the EPD TVS is vastly different from the traditional pn-junction devices. At voltages below 5V, high leakage current and junction capacitance render conventional avalanche technology impractical for most applications. However, by utilizing the EPD technology, these devices can effectively operate at 2.5V while maintaining excellent electrical characteristics.

The EPD TVS employs a complex nppn structure in contrast to the pn structure normally found in traditional silicon-avalanche TVS diodes. The EPD mechanism is achieved by engineering the center region of the device such that the reverse biased junction does not avalanche, but will “punch-through” to a conducting state. This structure results in a device with superior DC electrical parameters at low voltages while maintaining the capability to absorb high transient currents.

Circuit Board Layout Recommendations for Suppression of ESD.

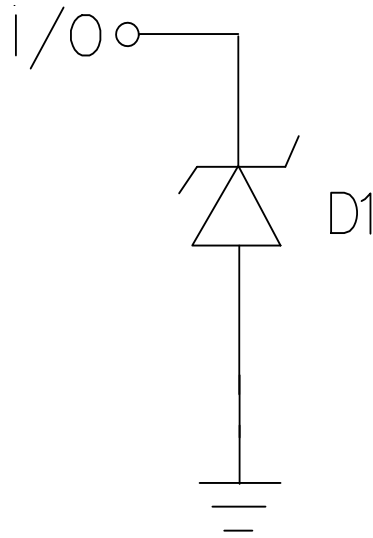
Good circuit board layout is critical for the suppression of ESD induced transients. The following guidelines are recommended:

- Place the TVS near the input terminals or connectors to restrict transient coupling.
- Minimize the path length between the TVS and the protected line.
- Minimize all conductive loops including power and ground loops.
- The ESD transient return path to ground should be kept as short as possible.
- Never run critical signals near board edges.
- Use ground planes whenever possible.

Device Schematic & Pin Configuration

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Applications Information - Spice Model

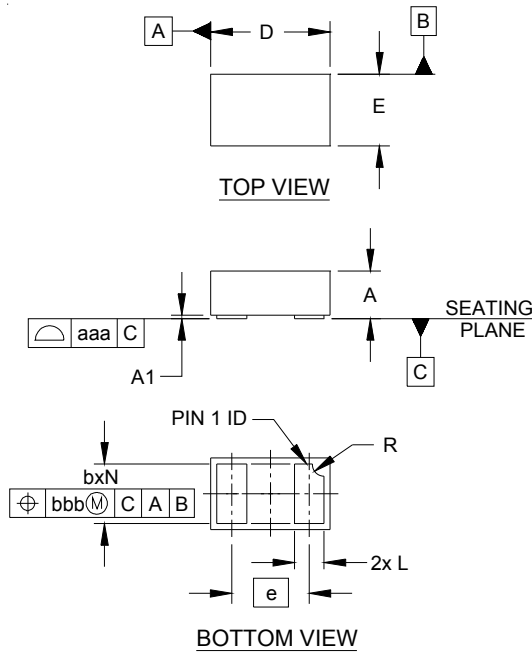


Spice Model

uClamp2501T Spice Parameters		
Parameter	Unit	D1 (TVS)
IS	Amp	9.5E-15
BV	Volt	2.81
VJ	Volt	0.72
RS	Ohm	0.707
IBV	Amp	1.0E-3
CJO	Farad	23E-12
TT	sec	2.541E-9
M	--	0.18
N	--	1.1
EG	eV	1.11

PROTECTION PRODUCTS

Outline Drawing - SLP1006P2T

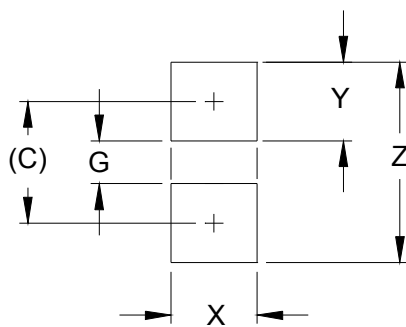


DIM	DIMENSIONS					
	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	.015	.016	.017	0.37	0.40	0.43
A1	.000	.001	.002	0.00	0.03	0.05
b	.018	.020	.022	0.45	0.50	0.55
D	.035	.039	.043	0.90	1.00	1.10
E	.020	.024	.028	0.50	0.60	0.70
e	.026 BSC			0.65 BSC		
L	.008	.010	.012	0.20	0.25	0.30
R	.002	.004	.006	0.05	0.10	0.15
N	2			2		
aaa	.003			0.08		
bbb	.004			0.10		

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

Land Pattern - SLP1006P2T



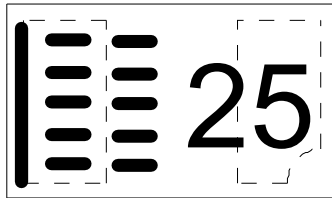
DIM	DIMENSIONS	
	INCHES	MILLIMETERS
C	(.033)	(0.85)
G	.012	0.30
X	.024	0.60
Y	.022	0.55
Z	.055	1.40

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

PROTECTION PRODUCTS

Marking Code



Ordering Information

Part Number	Working Voltage	Qty per Reel	Reel Size
uClamp2501T.TCT	2.5V	3,000	7 Inch

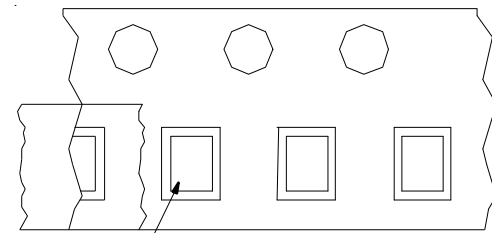
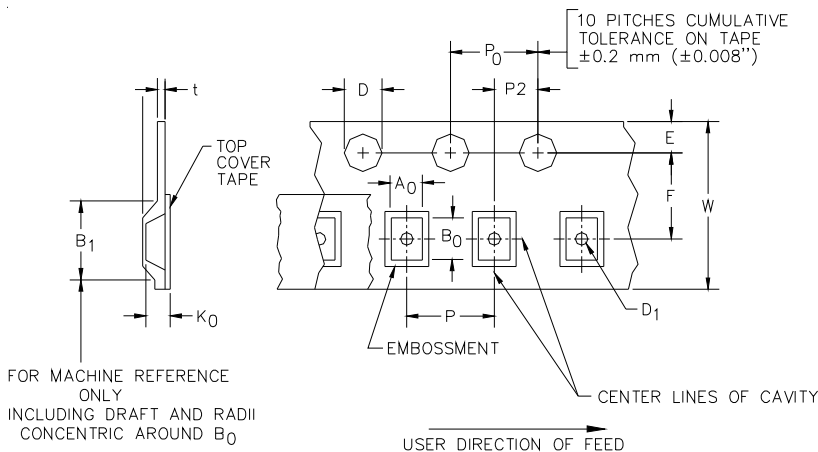
Notes:

1) MicroClamp, uClamp and μ Clamp are marks of Semtech Corporation

Notes:

1) Marking will also include line matrix date code

Tape and Reel Specification



Pin 1 Location

→ User Direction of feed

Device Orientation in Tape

A0	B0	K0
0.69 +/-0.10 mm	1.19 +/-0.10 mm	0.66 +/-0.10 mm

Tape Width	B, (Max)	D	D1	E	F	P	P0	P2	T	W
8 mm	4.2 mm (.165)	1.5 + 0.1 mm - 0.0 mm (0.59 +.005 -.000)	0.4 mm ±0.25 (.031)	1.750±.10 mm (.069±.004)	3.5±0.05 mm (.138±.002)	4.0±0.10 mm (.157±.00-4)	4.0±0.1 mm (.157±.00-4)	2.0±0.05 mm (.079±.002)	0.254±0.02 mm (.016)	8.0 mm + 0.3 mm - 0.1 mm (.312±.012)

Contact Information

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